157 Series – Standard Nano Fuse and Clip Assembly 🖓 🔊



Agency Approvals			
AGENCY	AGENCY FILE NUMBER	AMPERE RANGE	
c <b>FL</b> <sup>®</sup> us	E14721	0.062A ~ 10A	
PS E	NBK030205-E10480A NBK030205-E10480B NBK101105-E184655	1A 1.5A - 5A 6.3A - 10A	

#### Electrical Characteristics for Series

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Expertise Applied | Answers Delivered

% of Ampere Rating	Opening Time at 25°C
100%	4 hours Minimum
200%	5 secs. Maximum

# **Electrical Specifications by Item**

# Description

The 157 Series – Standard Nano Fuse/Clip assembly is a small, square, very fast acting surface mount fuse that is assembled in surface mountable fuse clips. The fuse clip and pre-installed fuse combination can be automatically placed in PC Board in one efficient manufacturing operation. It permits quick and easy replacement of fuses without performing desoldering process, even in the field and without exposing the PC Board to detrimental effects of rework solder heat.

#### Features

- Surface Mountable, Very Fast Acting Fuse.
- Fully compatible with RoHS/Pb-Free solder alloys and higher temperature profiles associated with leadfree assembly.
- Easily replaceable on PC Board (Field Replaceable)
- RoHS Compliant
- Available in ratings of 0.062 ~ 10 Amperes.

### Applications

- Instrumentation
- Base Stations
- Telecommunications

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Ampere Rating Amp (A) Code	Max	Interrupting	Nominal Cold	Nominal	Agency Approvals		
	Voltage Rating (V)	Rating (A)	Resistance (Ohms)	Melting I²t (A²sec)	c Nus	PSE	
0.062	.062	125		5.5372	0.00019	X	
0.125	.125	125		1.7059	0.00286	Х	
0.200	.200	125		1.3971	0.00652	Х	
0.250	.250	125		1.0496	0.01126	Х	
0.375	.375	125		0.6083	0.0425	Х	
0.500	.500	125		0.4181	0.0795	Х	
0.750	.750	125		0.2458	0.185	Х	
1.0	001	125		0.1537	0.459	Х	Х
1.5	01.5	125	50A @ 125 VAC/VDC	0.0634	0.853	Х	Х
2.0	002	125	300A @ 32 VDC	0.0373	0.530	Х	Х
2.5	02.5	125		0.0288	1.029	Х	Х
3.0	003	125		0.0229	1.650	Х	Х
3.5	03.5	125		0.0203	2.469	Х	Х
4	004	125		0.0163	3.152	Х	Х
5	005	125		0.0127	5.566	Х	Х
6.3	06.3	125		0.0098	9.17	Х	Х
7	007	125		0.0092	10.32	Х	Х
8	008	125		0.0079	20.23	Х	Х
10	010	125	35A @ 125 VAC / 50A @125 VDC 300A @ 32VDC	0.0058	26.46	X	Х

1. Cold resistance measured at less than 10% of rated current at 23°C.

I<sup>2</sup>t values stated for 8ms opening time.
 Agency Approval Table Key: X=Approved or Certified, P=Pending and Blank=Not Approved

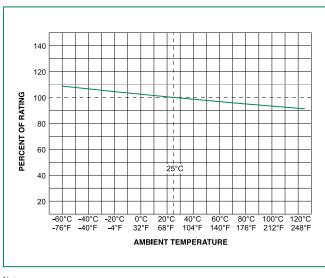
Agency Approval table Rey. X=Approved of Certified, F=Fending and Blank=Not Approved
 Have special electrical characteristic needs? Contact Littelfuse to learn more about application specific options.

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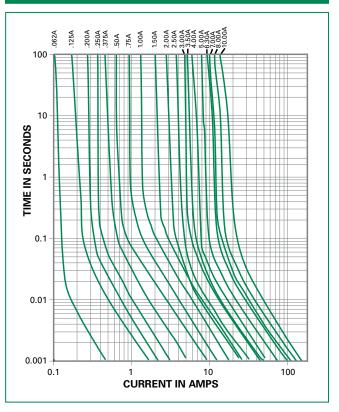
#### **Temperature Rerating Curve**

#### **Average Time Current Curves**



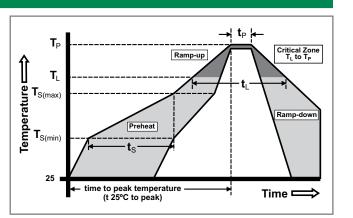
Note:

1. Derating depicted in this curve is in addition to the standard derating of 25% for continuous operation.



#### **Soldering Parameters**

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (Min to Max) (t <sub>s</sub> )	60 – 120 secs	
Average ramp up rate (LiquidusTemp $(T_L)$ to peak		5°C/second max.	
T <sub>S(max)</sub> to T <sub>L</sub> - Ramp-up Rate		5°C/second max.	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Temperature (t <sub>L</sub> )	60 – 90 seconds	
PeakTemperature (T <sub>P</sub> )		250 <sup>+0/-5</sup> °C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		20 – 40 seconds	
Ramp-down Rate		5°C/second max.	
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes max.	
Do not exceed		260°C	



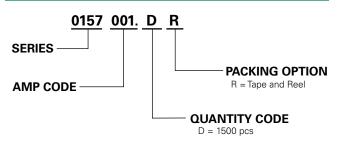


## **Product Characteristics**

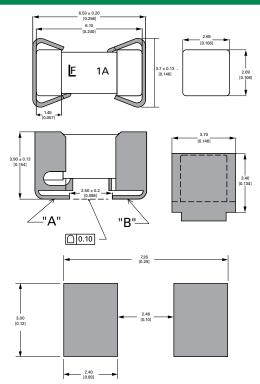
Materials	<ul> <li>Body: Ceramic</li> <li>Cap: For 0.062A ~ 0.125A – Au plated Brass For 0.200A ~ 10A – Silver plated Brass</li> <li>Clip Plating: Matte Tin</li> </ul>	
Product Marking	Body: Brand Logo, Current Rating	
Clip Retention	Force applied at fuse center, perpendicular to the long axis (@ 0.75 lbs. MIN)	
Solderability	MIL-STD-202, Method 208 / IPC/ EIA / JEDEC J-STD002B, Test Condition A	
Humidity Test	MIL –STD-202, Method 103 @ 85°C / 85%RH, 1000 hours	
Resistance to Solvents	MIL-STD-202, Method 215 (3 solvent types)	

Operating Temperature	-55°C to 125°C with proper derating		
Thermal Shock	MIL-STD-202, Method 107, Test Condition B (5 cycles -65°C to +125°C)		
Vibration	MIL-STD-202, Method 201 (10-55 Hz)		
Moisture Resistance	MIL-STD-202, Method 106, 10 cycles		
Salt Spray/ Atmosphere	MILSTD-202, Method 101, Test Condition B (48 hrs.), 5% NaCl in De-ionized Water		
Shock	MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 milliseconds)		

### Part Numbering System



## Dimensions



PCB Recommendation for Thermal Management

Alternate methods of thermal management may be used. In such cases, under normal operations, the maximum temperature of the fuse body should not exceed 80°C in a 25°C ambient environment.

Packaging					
Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code		
Tape and Reel	Surface Mount	1500	DR		

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Specifications are subject to change without notice. Please refer to www.littelfuse.com/series/157.html for current information.

Minimum Copper Layer Thickness = 100um
 Minimum Copper Trace Width = 10mm

Note: